

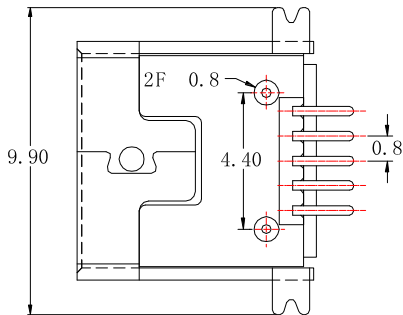
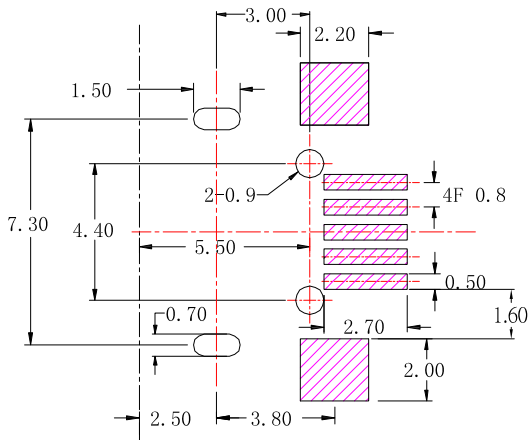
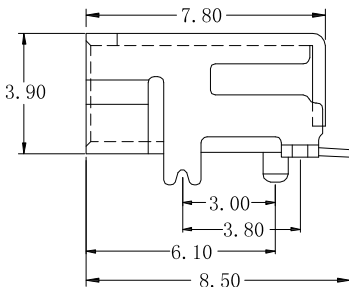
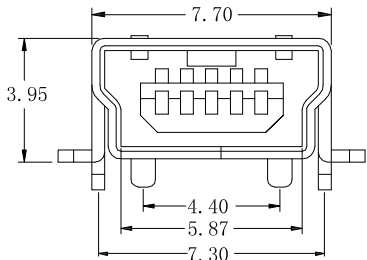
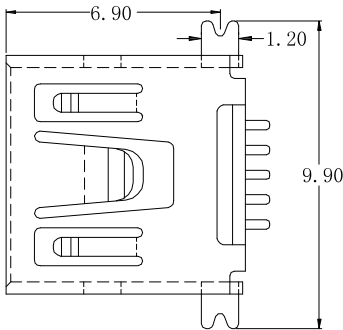
MUSB-5B-SD3-x-S175

鍍層厚度：

Blank : 1u"

2 : 15u"

3 : 30u"



SPECIFICATIONS

Electrical :

- 1.Current Rating : 1.0A / contact terminal
- 2.Voltage Rating : 30V DC
- 3.Contact Resistance : 50 mΩ Max
- 4.Dielectric Withstanding Voltage : 300V AC
- 5.Insulation Resistance : 100 MΩ Min

Material :

- 1.Housing : LCP,UL 94V-0, Black
- 2.Contact : PHOSPHOR BRONZE
- 3.Shell : BRASS

Finish :

- 1.Contact : Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell : Nickel under Plated surface layer

P.C.B LAYOUT MOUNTING PATTERN

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD. ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao
DATE: 03/12/18
DATE: 03/12/18
DATE: 03/12/18

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	MINI USB B TYPE SMT (SHELL : 前DIP後SMT)
SCALE	DWG NO.	MUSB-5B-SD3-x-S175
SHEET NO.	PART NO.	MUSB-5B-SD3-x-S175

ITEM NO.	DESCRIPTION	DRAWN	DATE
1	新增PCB LAYOUT尺寸	Jack	031218